

# LAN3VSOP

## 2.5G BASE-T LAN transformer, PoE



Photo is representative

### Product features

- IEEE 802.3bz, 802.3.at compliant
- 1500 Vac isolation between primary and secondary
- Dual port, PoE, CMC/xfrm/CMC structure
- Toroid core winding, open header, surface mount
- Weight 4.28 g typical
- Moisture sensitivity level (MSL): 1

### Applications

- SELV/ELV equipment
- IP telephones
- Wireless LAN access point
- IoT, Remote monitoring
- Smart TV
- Network camera
- Data centers

### Environmental compliance and general specifications

- Operating ambient temperature range: -40 °C to +85 °C
- Storage temperature range (component): -40 °C to +125 °C



**Product specifications** (+25 °C)

Meets IEEE 802.3 at Standards 1150 mA current capability Per PoE Port /Two-pair.

Part number <sup>4</sup>	Port	Pins	Inductance <sup>1,5</sup> ( $\mu$ H)	Leakage inductance <sup>1,5</sup> ( $\mu$ H)	DCR <sup>2,5</sup> ( $\Omega$ )	CWW <sup>1,5</sup> (pF)	Turns Ratio <sup>3</sup>	Insertion loss <sup>3,5</sup> (dB)	Return loss <sup>3,5</sup> (dB)	Cross talk <sup>5</sup> (dB) (between each channel)	CMRR <sup>3,5</sup> (dB)	DCMR <sup>3,5</sup> (dB)
LAN3VSOPD48151C2*	Dual	48	180 @ 0 mA DC Bias	0.5	1.0 (Sec) 1.6 (Pri)	35	1CT:1CT, $\pm 2\%$	-1 @ 1-100 MHz	-20 @ 1-40 MHz	-32 @ 10-100 MHz	-14 @ 10-200 MHz	-26 @ 10-200 MHz
			150 @ 15 mA DC Bias					-20+15*log(f/40) @ 40-200 MHz	-25 @ 100-200 MHz	-8 @ 200-500 MHz	-16 @ 200-500 MHz	-7 @ 500-1000 MHz

1. Inductance (Transformer side), Leakage Inductance (Transformer side, short CMC side), CWW (Interwinding capacitance, Pri to Sec): Test parameters: 100 kHz, 0.2 V

2. DCR: CMC side

3. Turns ratio, Insertion loss, return loss, DCMR (Differential to common mode rejection) and CMRR (Common mode rejection ratio): Primary to secondary: Polarity pin 1 side in phase

\*= Operating temperature: (temperature rise not included) -40 °C to +85 °C

LAN3VSOPD48151C2: temperature rise  $\leq$  50 °C

Hipot: 1500 Vac primary to secondary

4. Part number definition: LAN3VSOPxxx151xx

LAN3VSOP= Product code

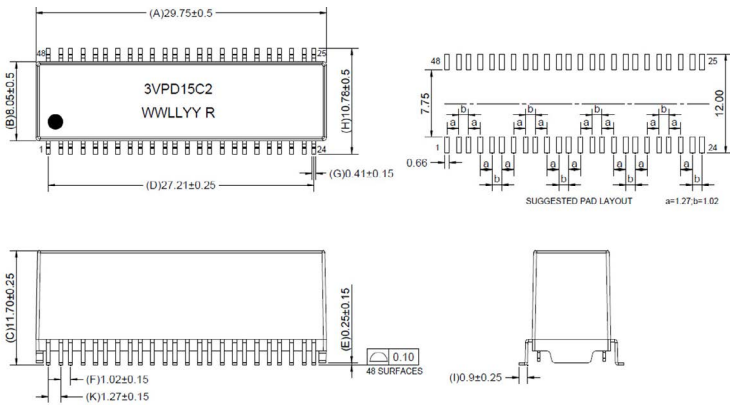
xxx: D48 = Dual port, 48 pin

xx: C2 = -40 to +85 °C

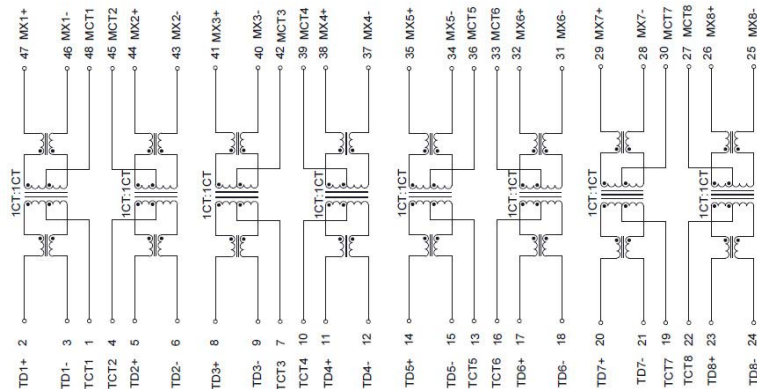
5. DCR, CWW, Leakage inductance and Insertion loss values are maximum; Inductance, Return loss, CMRR, DCMR and Cross talk values are minimum

**Mechanical parameters (mm)**

**LAN3VSOPD48151C2**



**Schematic**



Part marking: 3VPD15C2, WWLLYY R = Lot code, Dot indicates pin 1

Pin length does not include include solder point

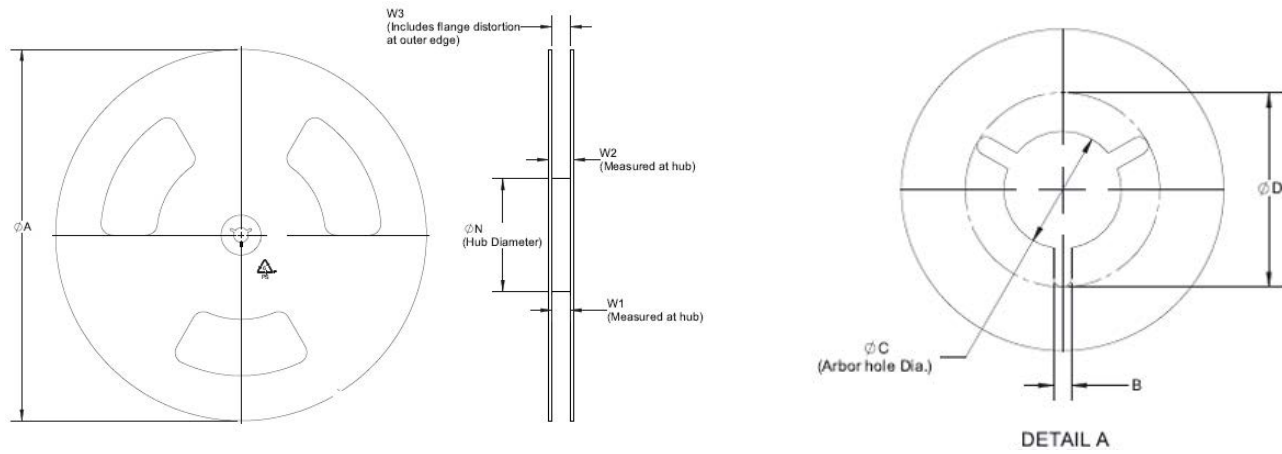
Silkscreen thickness: 0.1 mm to 0.15 mm

Traces or vias underneath the transformer is not recommended

**Packaging information (mm)**

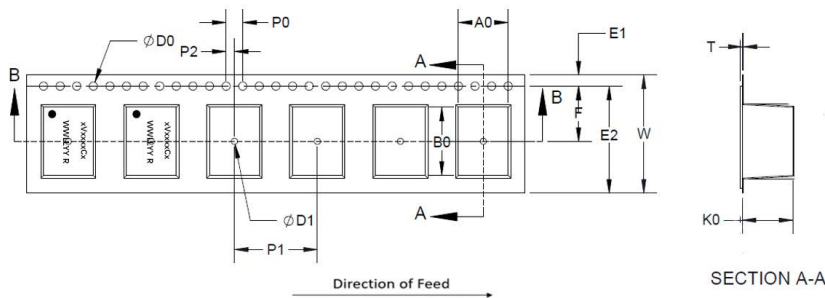
Drawing not to scale

Supplied in tape and reel packaging on a 13" diameter reel, EIA-481 compliant



**Reel dimension (mm)**

Part number	$\varnothing A$	B	$\varnothing C$	$\varnothing D$	$\varnothing N$	W1	W2	W3
LAN3VSOPD48151C2	$330 \pm 2$	1.5 min	$13 + 0.5 / -0.2$	20.2 min	100	$56.4 + 2 / -0$	62.4 max	N/A



**Tape dimension (mm)**

Part number	Ao	Bo	Ko	T	W	F	E	E2	P0	P1	P2	$\varnothing D0$	$\varnothing D1$
LAN3VSOPD48151C2	$11.25 \pm 0.1$	$30.1 \pm 0.1$	$12.4 \pm 0.1$	$0.5 \pm 0.05$	$56 \pm 0.3$	$26.2 \pm 0.15$	$1.75 \pm 0.1$	53.85 min	$4 \pm 0.1$	$24 \pm 0.1$	$2 \pm 0.1$	$1.5 + 0.1 / -0$	2.0 min

**Packaging quantity**

Part number	Reel	Bag	Box	Carton
LAN3VSOPD48151C2	190	190	190	760

### General specifications

Solderability	J-STD-002.	8 hours steam age test, Solder: +245 °C ± 5 °C (5 s)
Reflow	MIL-STD-202G Condition J	+260 °C ± 5 °C, 30 s ± 5 s, 1 times reflow
Resistance soldering heat	MIL-STD-202H, Method 210	+260 °C , 10 s
Operational life	MIL-STD-202, Method 108	1000 hours, +85 °C @ 1150 mA
Temperature cycling	MIL-STD-202G	High temperature= +125 °C, low temperature -40 °C, conversion time 15 minutes, 32 cycles
Biased humidity	MIL-STD-202G	+85 °C, 85% RH, Duration= 1000 hours
Vibration	MIL-STD-202	10 Hz to 80 Hz, Increased at +3 dB/octave, 80 Hz to 350 Hz, 0.053 g <sup>2</sup> /Hz, 350 Hz to 2000 Hz, Decrease at -3 dB/octave, X, Y and Z vibrate for 15 minutes each.
Mechanical shock	MIL-STD-202, Method 213	Half-sine shock pulse, peak=50 g's, 11 ms, total 18 shocks
Terminal strength	CBA203A-001	Standard: 4.5 kg, Minimum: 60 s, no visible damage

Solder reflow profile



Table 1 - Standard SnPb solder (T<sub>C</sub>)

Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T<sub>C</sub>)

Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T <sub>smin</sub> )	100 °C	150 °C
• Temperature max. (T <sub>smax</sub> )	150 °C	200 °C
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds
Ramp up rate T <sub>L</sub> to T <sub>p</sub>	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T <sub>L</sub> )	183 °C	217 °C
Time (t <sub>L</sub> ) maintained above T <sub>L</sub>	60-150 seconds	60-150 seconds
Peak package body temperature (T <sub>p</sub> )*	Table 1	Table 2
Time (t <sub>p</sub> )* within 5 °C of the specified classification temperature (T <sub>C</sub> )	20 seconds*	30 seconds*
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

\* Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

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**Eaton**  
Electronics Division  
1000 Eaton Boulevard  
Cleveland, OH 44122  
United States  
Eaton.com/electronics

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